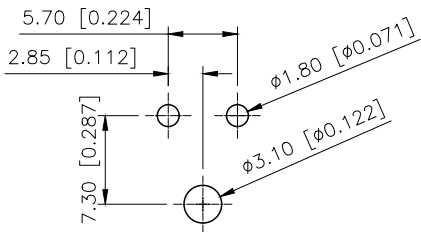
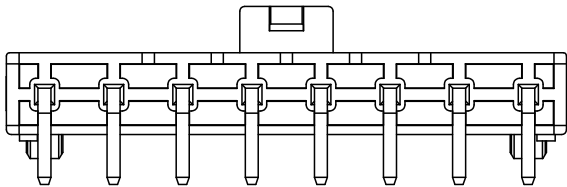
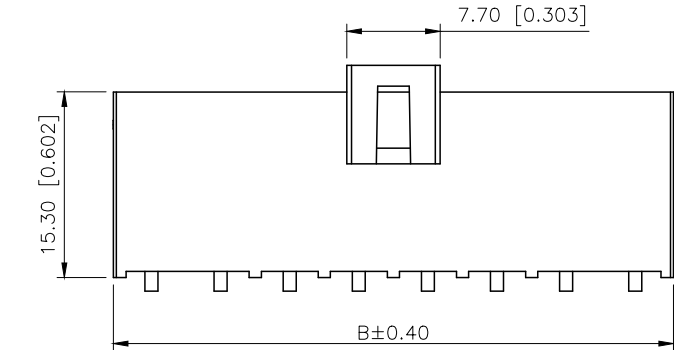
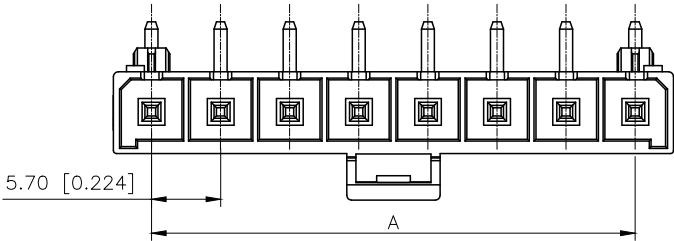
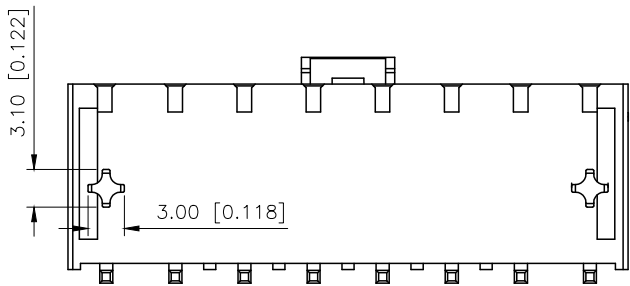
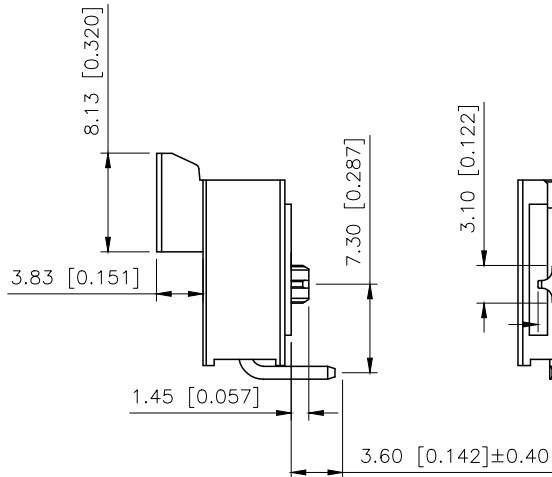


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2024.12.6	阿树



2 PIN
PCB Board Layout



PART NO.:

X5701 W R-XX-LP SW
① ② ③ ④ ⑤ ⑥

Specifications:

规格:

Voltage rating:600V AC/DC
额定电压: 600V AC/DC
Current rating:23A AC/DC
额定电流: 23A AC/DC
Withstanding voltage:2200V AC/minute
耐受电压: 2200V AC/分钟
Temperature range:-40℃-+125℃
温度范围: -40℃-+125℃
Insulation resistance:1000MΩ min
绝缘电阻: 1000MΩ Min
Contact resistance:10mΩ Max
接触电阻: 10mΩ Max

- ①Series No
②Category:W-Wafer
③Welding Board Angle:R-Stright 90°
④Row No.Pin No:XX-02~12P ;N=4~12P
⑤Material:LP-LCP UL94V-0
⑥Plating:SW-Matte Tin Plating

Circuits	2	N
DIM .A	5.70	5.7xN-5.7
DIM .B	12.05	5.7xN+0.65
DIM .C	/	5.7x(N-2)

3~8 PIN
PCB Board Layout



AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



X5701WR-XX-LPSW	LCP	High Contactivity Copper Alloy	X5701H
PART NO	Material	Material(Pin)	Suitable XKB Housing

DESIGN	阿树	VIEW:	MODEL TYPE: 5.7mm Crimp Style Connector
CHECKED		UNIT: mm/in	PART NO.: X5701WR-XX-LPSW
APPROVED		SIZE: A4	DWG NO.: